



40V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	RDS(ON) Max	I _D Tc = +25°C
40)/	13mΩ @ V _{GS} = -10V	-80A
-40V	23mΩ @ V _{GS} = -4.5V	-60A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Reverse-polarity protection
- **BLDC** motor controls
- Power-management functions

Features and Benefits

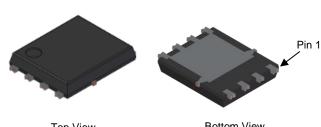
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Wettable Flank for Improved Optical Inspections
- Low On-Resistance
- Fast Switching Speed
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

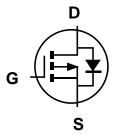
Mechanical Data

- Package: PowerDI®5060-8
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish 100% Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.097 grams (Approximate)

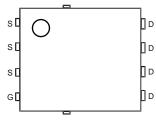
PowerDI5060-8/SWP (Type UX)



Bottom View Top View



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Orderable Part Number	Pookogo	Packing		
	Package	Qty.	Carrier	
DMP4012SPSW-13	PowerDI5060-8/SWP (Type UX)	2,500	Reel	

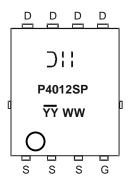
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

PowerDI is a registered trademark of Diodes Incorporated in the United States and other countries.



Marking Information



Ottle Manufacturer's Marking
P4012SP = Product Type Marking Code
YYWW or YYWW = Date Code Marking
YY or YY = Year (ex: 25 = 2025)
WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			VDSS	-40	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current, $V_{GS} = -10V$ (Note 6) Steady $T_{C} = +25^{\circ}C$ State $T_{C} = +70^{\circ}C$			ID	-80 -60	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-320	Α
Maximum Body Diode Continuous Current (Note 6)			Is	-80	Α
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	-320	Α
Avalanche Current, L = 1mH			las	-14.7	Α
Avalanche Energy, L = 1mH			Eas	108	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25^{\circ}C$	P_{D}	3.3	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	45	°C/W
Total Power Dissipation (Note 6)	$T_C = +25^{\circ}C$	P_{D}	139	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	0.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

otes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).



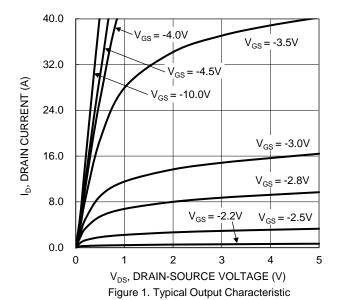
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

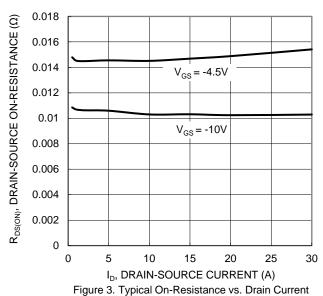
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	-40	_	_	V	$V_{GS} = 0$, $I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μΑ	V _{DS} = -40V, V _{GS} = 0	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0$	
ON CHARACTERISTICS (Note 7)	ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	Vgs(th)	-1	_	-3	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	D	_	9.8	13	0	V _G S = -10V, I _D = -10A	
Static Drain-Source On-Resistance	RDS(ON)	_	14.1	23	mΩ	$V_{GS} = -4.5V, I_{D} = -8A$	
Diode Forward Voltage	V _{SD}	_	-0.7	-1.2	V	V _{GS} = 0, I _S = -1A	
DYNAMIC CHARACTERISTICS (Note 8)						•	
Input Capacitance	Ciss	_	3643	_		V _{DS} = -20V, V _{GS} = 0, f = 1MHz	
Output Capacitance	Coss	_	306	_	pF		
Reverse Transfer Capacitance	Crss	_	259	_			
Gate Resistance	Rg	_	2.4	_	Ω	$V_{DS} = 0$, $V_{GS} = 0$, $f = 1MHz$	
Total Gate Charge (VGS = -4.5V)	Qg	_	33.4	_			
Total Gate Charge (V _{GS} = -10V)	Qg	_	68.6	_		\/ 20\/ I- 40A	
Gate-Source Charge	Qgs	_	12.7	_	nC	V _{DS} = -20V, I _D = -10A	
Gate-Drain Charge	Qgd	_	11.1	_			
Turn-On Delay Time	t _{D(ON)}	_	5.5	_		$V_{GS} = -10V, V_{DD} = -20V,$ $R_{G} = 3\Omega, I_{D} = -10A$	
Turn-On Rise Time	t _R	_	22	_			
Turn-Off Delay Time	tD(OFF)	_	76.5	_	ns		
Turn-Off Fall Time	tF	_	42	_			
Reverse-Recovery Time	trr	_	52.5	_	ns	I _F = -10A, di/dt = -100A/μs	
Reverse-Recovery Charge	Q_{RR}	_	39	_	nC	$I_F = -10A$, $di/dt = -100A/\mu s$	

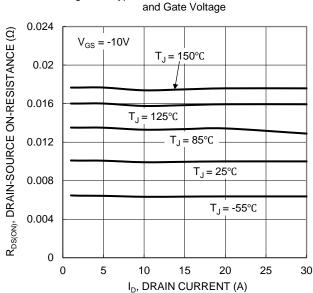
7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing. Notes:

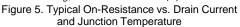


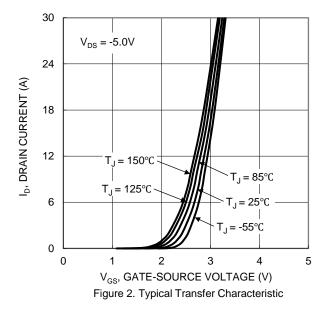


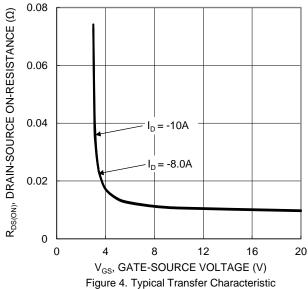












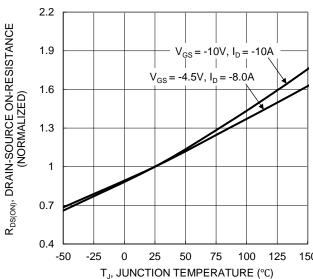


Figure 6. On-Resistance Variation with Junction Temperature





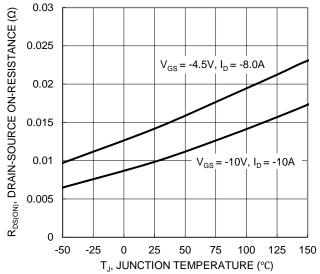
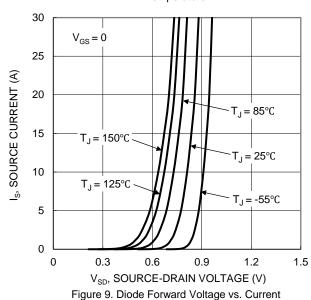


Figure 7. On-Resistance Variation with Junction Temperature

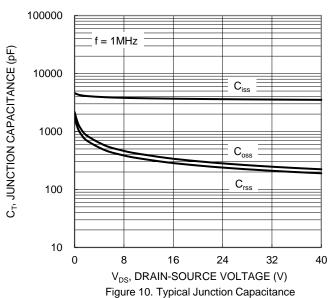


10 8 6 $V_{GS}(V)$ 4 $V_{DS} = -20V, I_{D} = -10A$ 2 0 0 36 9 18 27 45 54 63 72 Q_q (nC)

Figure 11. Gate Charge

3 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) 2.5 2 $I_D = -1mA$ 1.5 $I_D = -250 \mu A$ 1 0.5 0 -25 0 25 50 75 100 125 150 -50 T_J, JUNCTION TEMPERATURE (°C)

Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $R_{DS(ON)}$ Limited $P_W = 10\mu s$ $P_W = 100\mu s$ P

Figure 12. SOA, Safe Operation Area



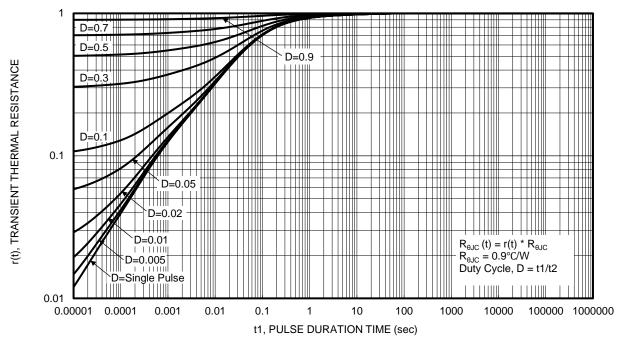


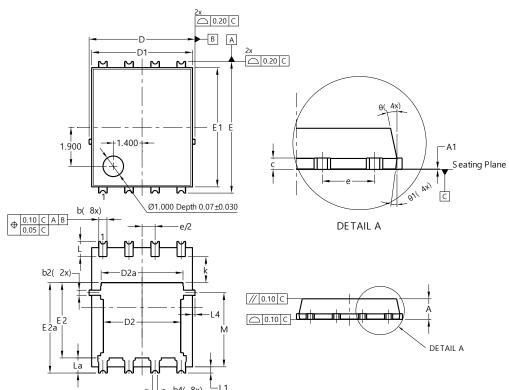
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)

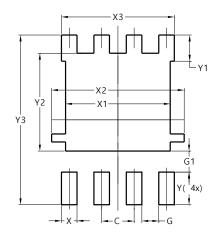


PowerDI5060-8/SWP					
(Type UX)					
Dim	Min	Тур			
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	0).25REF			
С	0.230	0.330	0.277		
D	5	.15 BS0)		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
Е	6	.40 BS0			
E1	5.60 6.00		5.80		
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1.27BSC				
k	1.05				
┙	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L4	0.025	0.225	0.125		
M	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Υ	1.270		
Y1	1.020		
Y2	3.810		
V٦	6.610		



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